List of Publications

Published Articles

- Jha, R., Rao, M. D., Meshram, A., Verma, H. R., & Singh, K. K. (2020). **Potential of polymer inclusion membrane process for selective recovery of metal values from waste printed circuit boards: A review**. *Journal of Cleaner Production*, *265*, 121621. https://doi.org/10.1016/j.jclepro.2020.121621

- Jha, R., Agrawal, M., & Singh, K. K. (2023). **Synthesis and Characterisation of PVC-based non- plasticised polymer inclusion membranes for selective metal extraction**. *Canadian Metallurgical Quarterly*, 1–11. https://doi.org/10.1080/00084433.2023.2175302

- Jha, R., Sharma, R., Agrawal, M., Dhanunjaya Rao, M., & Singh, K. K. (2023). **Exploring the pretreatment routes of waste printed circuit boards for enhanced metal recovery.** *Materials Today: Proceedings*, *July*. https://doi.org/10.1016/j.matpr.2023.08.006

- Jha, R., Mishra, G., Agrawal, M., Dhanunjaya Rao, M., Meshram, A., & Singh, K. K. (2022). **Opportunities for an en-route to polymer inclusion membrane approach from conventional hydrometallurgical recycling of WPCBs: a mini-review**. In *Canadian Metallurgical Quarterly* (Vol. 0, Issue 0, pp. 1–15). https://doi.org/10.1080/00084433.2022.2126576

- Jha, R., Agrawal, M., Jena, A., Mishra, G., Verma, H. R., Meshram, A., & Singh, K. K. (2024). **A review on existing pre-treatment techniques of waste printed circuit boards.** In *Canadian Metallurgical Quarterly* (pp. 1–17). https://doi.org/10.1080/00084433.2024.2310348

- Jha, R., et al., Exploration of polymer inclusion membrane for nickel recovery from waste printed circuit boards, *Process Safety and Environmental Protection* https://doi.org/10.1016/j.psep.2024.07.051

Under Review

- Jha, R., et al., Copper leaching from ultrasonically treated milled waste printed circuit boards: Investigation of parameters optimization and kinetics, *Environmental science and pollution research (ESPR-D-24-05380)*

- Jha, R., et al., Nickel leaching from obsolete mobile printed circuit boards: Parameters optimization and kinetics, *Energy Sources, Part A: Recovery, Utilization, and Environmental Effects, (240400999)*

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